# AN11379 BFU530A ISM 433 MHz LNA design Rev. 1 — 20 January 2014

Application note

#### **Document information**

Info	Content
Keywords	BFU520, BFU530, BFU550 series, ISM-band, 433MHz 866MHz
Abstract	This document describes an ISM Frequency LNA design on BFU5xxA Starter kit
Ordering info	BFU5xxA Starter kit OM7961, 12nc 9340 678 69598
Contact information	For more information, please visit: <a href="http://www.nxp.com">http://www.nxp.com</a>



#### **Example LNA design using BFU530A**

#### **Revision history**

Rev	Date	Description
1	20140120	First publication

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#### **Example LNA design using BFU530A**

#### 1. Abstract

In this application note an ISM band (industrial, scientific and medical) LNA design (low noise amplifier) using a BFU5xx transistor from NXP latest wideband transistor range is described. It shows the design, simulation and implementation phases. Together with measurement results, parameters measured over temperature are shown.

The application note (AN) can be a starting point for new design(s), and/or derivative designs.

#### 2. Introduction

The BFU5xxA transistor family is designed to meet the latest requirements on high frequency applications (up to approximately 2 GHz) such as communication, automotive and industrial equipment. As soon as fast, low noise analogue signal processing is required, combined with medium to high voltage swings the BFU5xxA transistors are the perfect choice. Due to the high gain at low supply current those types can also be applied very well in battery powered equipment.

Compared to previous Philips / NXP transistor generations and competitor products' improvements on gain, noise and thermal properties are realized. BFU5xxA transistors are available in various packages.

The transistors are promoted with a full promotion package, called "starter kits" (one kit type per package-type). Those kits include two PCB's (one with grounded emitter, one with emitter degeneration provision), RF connectors, transistors and simulation model parameters required to perform simulations. See the overview of available starter kits in the table below.

Table 1. Customer evaluation kits

	Basic type	Customer evaluation kits
1	BFU520W, BFU530W, BFU550W	OM7960, starter kit for transistors in SOT323 package
2	BFU520A, BFU530A, BFU550A	OM7961, starter kit for transistors in SOT23 package
3	BFU520, BFU530, BFU550	OM7962, starter kit for transistors in SOT143 package
4	BFU520X, BFU530X, BFU550X	OM7963, starter kit for transistors in SOT143X package
5	BFU520XR, BFU530XR, BFU550XR	OM7964, starter kit for transistors in SOT143XR package
6	BFU580Q, BFU590Q	OM7965, starter kit for transistors in SOT89 package
7	BFU580G, BFU590G	OM7966, starter kit for transistors in SOT223 package

#### Example LNA design using BFU530A

Basic type

Customer evaluation kits



Fig 1. BFU5xxA evaluation boards

# 3. Requirements

The demonstrator circuit is designed to show the BFU530A capabilities for a 433 MHz ISM LNA with strong focus on best possible Noise Figure at low to medium supply current.

The aim of the demonstrator circuit was to design a LNA optimized for the ISM band for battery powered equipment meeting following requirements:

Supply Voltage: 3.6 Volts nominal

Supply current: 10mA at ambient temperature

Noise Figure: < 1.3dB Gain: approx. 15dB

OIP3: priority on NF but preferably >+13dBm

Input Return-Loss: < -8dB Output Return-Loss: < -10dB

The design is aimed at low BOM cost and small PCB area, inductors are SMD types (preferable low cost multilayer types) to enable simple tuning to other frequency bands.

# 4. Design considerations

In order to achieve minimum Noise Figure, with Gain still close to the maximum available gain, the source impedance has to be close to the optimum for Noise Figure and not too far from to the maximum gain impedance. Designing for optimum Noise Figure will compromise, for example, the input return loss, but this is assumed to be acceptable.

At any time the circuit should be stable, hence during the design phase the K-factor needs to be observed carefully.

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#### **Example LNA design using BFU530A**

# 5. Design approach

The design starts in the simulation phase, applying the Mextram Model (available at http://www.nxp.com). Agilent "Advanced Design System" (ADS) was used for this but other simulation software packages should give equal results. Spice / Gummel Poon models are available.

Once simulation results meet the requirements, the circuit is built on a universal Printed Circuit Board (PCB) and evaluated. If measurement results show significant offset from simulated results, fine tuning is required until required performance is met. To achieve better matching between simulations and measurements, the PCB parasitic properties were added in the simulation template.

Following blocks of passive components can be identified:

- 1) resistors for DC biasing
- 2) passives set up collector load
- 3) passives for output matching
- 4) passives for input matching
- 5) passives required to ensure stable operation

Each block will be discussed separately below.

## 5.1 Simulation steps

Following simulation / design approach can be useful:

- 1) Configure the DC bias set-up, ensuring the lcc is set around desired value.
- 2) Configure the collector load circuit and output matching circuitry, optimizing the output Return Loss (RL).
- 3) Check stability.
- 4) Configure the input matching, for LNA optimize for minimum noise figure (NF) but keep close to optimum gain, if possible optimum NF gain points should be close.
- 5) Check stability.

#### Assumptions:

- Realistic passives are used by applying Murata design kit (0603 / 0402)
- PCB tracks represented by strip-lines

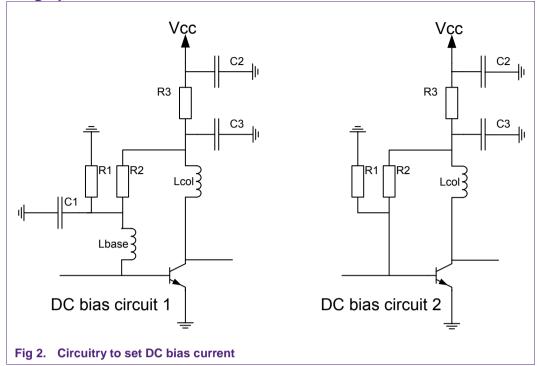
#### 5.2 Implementation / evaluation steps

Following implementation / evaluation steps have been executed:

- 1) Implement simulated design on universal PCB.
- 2) Evaluate LNA on Gain / NF / matching / Stability at ambient temperature.
- 3) Fine tune passives if required.
- 4) In case significant differences between simulations and measured results are observed, try to modify parasitic properties in the simulation template.
- 5) Measure LNA design on RF parameters over temperature.

#### **Example LNA design using BFU530A**

#### 5.3 Setting up the DC bias circuit



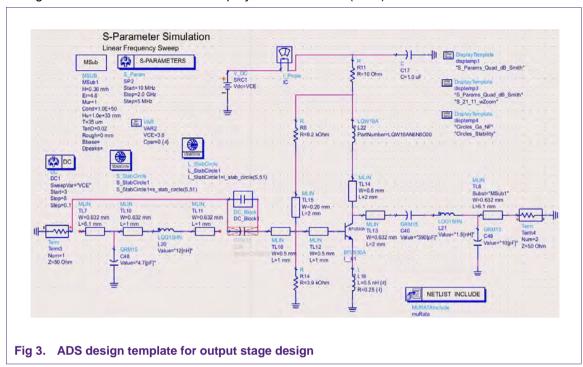
Circuit 1 has the advantage that resistive noise from the resistors R1 and R2 is suppressed by capacitor C1, but at the cost of an extra inductor. This inductor can be part of the input matching.

Circuit 2 is commonly used and saves two passive components. Both circuits tend to have increasing collector current (Icc) with increasing temperature, partly stabilized by R3. Increasing R3 will have impact on the linearity (OIP3, P1dB).

## **Example LNA design using BFU530A**

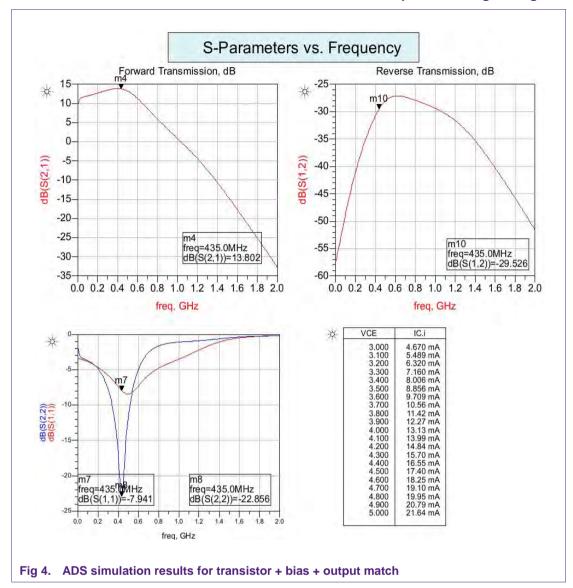
## 5.4 Definition of collector load and output match

The configuration used and simulation display is shown below (ADS).

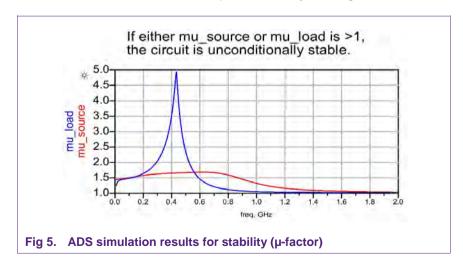


In this simulation for the 433 MHz ISM Band the input matching circuit is bypassed. The components L21,C49 are tuned to get a match in the required frequency band.

#### **Example LNA design using BFU530A**



After defining the configuration for the collector load / output matching network and tuning the component values, a simulation is executed to observe the amplifiers stability. See figure below.

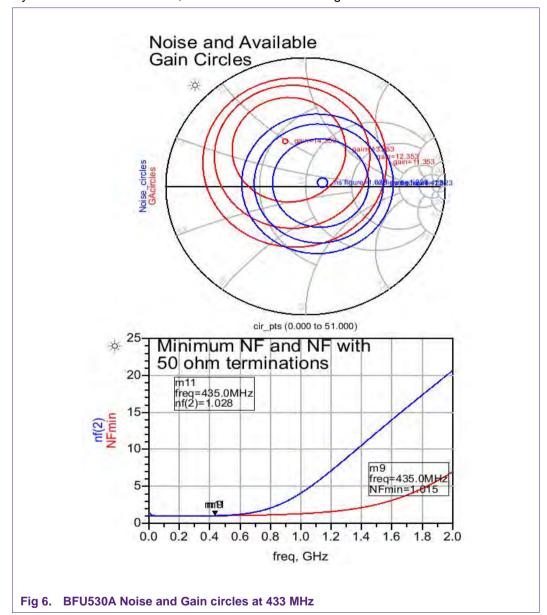


#### **Example LNA design using BFU530A**

## 5.5 Definition of input / source matching circuit

In case the amplifier has to be designed to get minimum noise figure, the "noise and gain circles" can be applied.

See figure below: In the noise circles plot you can find the area for optimum source impedance, as should be seen by the base of the transistor, to achieve lowest noise figure.



This is the result from simulations of the set-up as shown in section 5.4, Fig 3.

In this Smith Chart you can find the optimum load impedance for optimum noise in the smallest blue circle, NF 0.76dB (this is the expected NF for the transistor without matching/PCB losses). In case the source impedance is shifted into the region of the second blue circle, the NF will be increased by approximately 0.2dB.

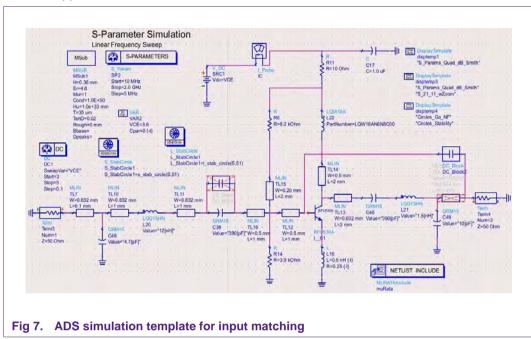
The same applies to the Gain, but in that case the red circles needs to be considered.

The input matching network needs to be set up such that the source impedance as seen by the transistor is close to the optimum for NF, preferably also close to optimum gain circle.

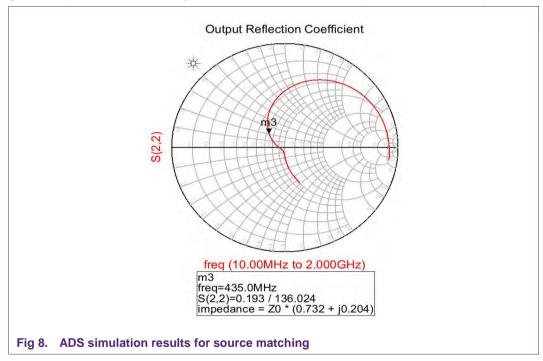
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#### **Example LNA design using BFU530A**

In the next figure the simulation template to optimize for best source impedance is shown. Please note that the active part of the circuit is bypassed. We want to observe the S22 which is the source impedance for the transistor applied.



By tuning the components L20, C48 you could move the source impedance towards required area.

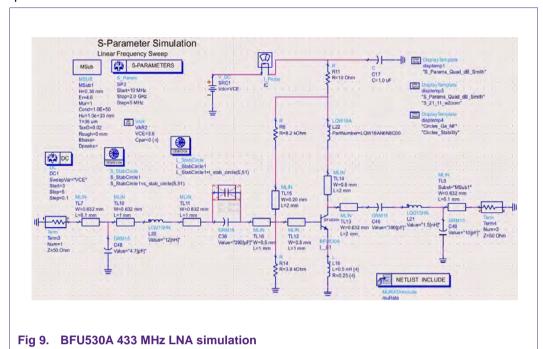


From this figure we see the source impedance at 433 MHz is in the area we want.

#### **Example LNA design using BFU530A**

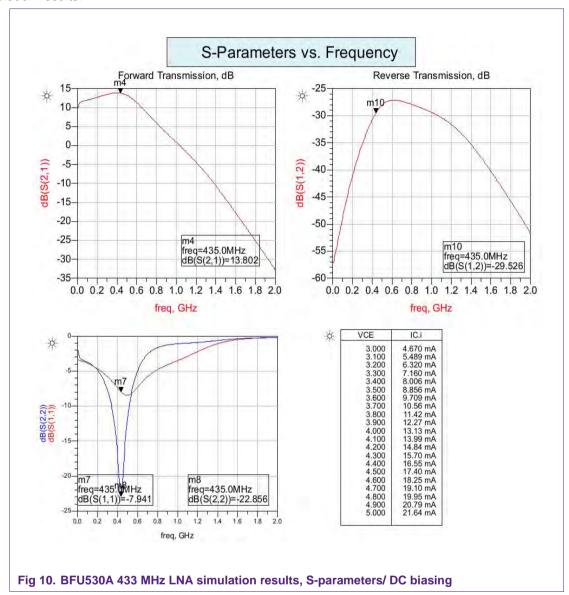
## 5.6 Overall LNA simulation

#### ADS template used:



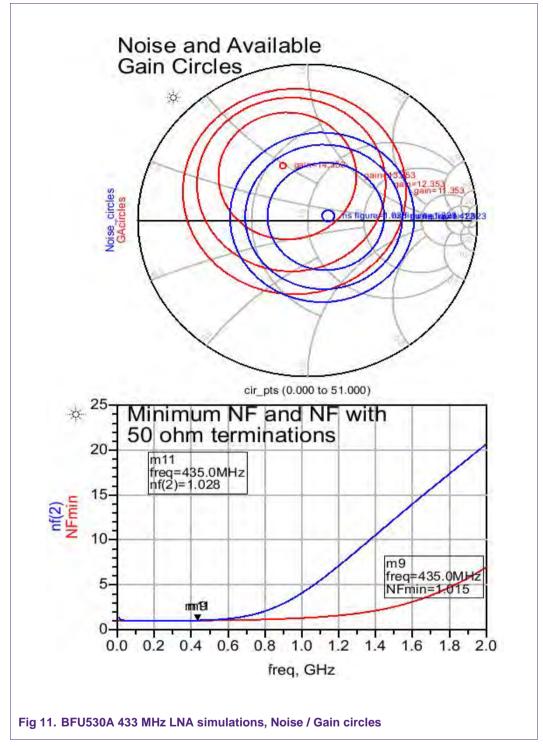
#### **Example LNA design using BFU530A**

#### Simulation results:



S-parameters at 3.6 Volt.

**Example LNA design using BFU530A** 



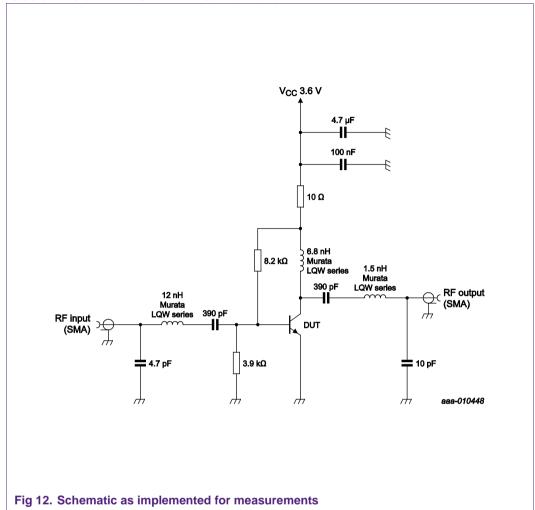
Compared to the noise circles of the unmatched circuit (section 5.5), we can clearly see the optimum noise point has moved towards the ideal 50R point.

#### **Example LNA design using BFU530A**

# 6. Application circuit

The circuit diagram of the evaluation board is shown in Fig 12 PCB schematic.

#### 6.1 BFU530A 433 MHz ISM LNA schematic



The PCB layout used for our internal evaluations did not accommodate the 33nH inductor to be in the bias path (as shown in the ADS schematics) the input matching inductor was placed to ground (GND) and an additional DC blocking capacitor (220pF) was used. This should give equal results and a slight improvement on the Noise Figure can be expected as the resistive noise from the two bias resistors is not suppressed by a blocking capacitor to GND.

#### **Example LNA design using BFU530A**

## 6.2 BFU530A 433 MHz ISM LNA PCB drawing

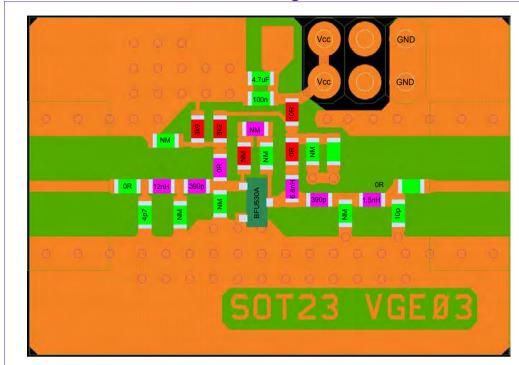


Fig 13. PCB implementation for measurements

#### Remarks:

0R = SMD jumper

NM = component not mounted.

This layout, as delivered with the Starter kit, accommodates the possibility to implement the biasing as shown in the ADS schematics.

# 6.3 PCB properties, layer stack

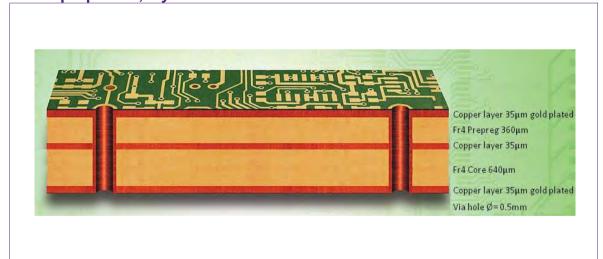


Fig 14. PCB layers used for Evaluation Boards in Starter kit

## **Example LNA design using BFU530A**

# 6.1 Typical LNA evaluation board results

Table 2. Typical results measured on the evaluation boards

Operating Frequency is f = 433 MHz unless otherwise specified; Temp = 25 °C

Parameter	Symbol	EVB	Unit	Remarks
Supply Voltage	$V_{CC}$	3.6	V	
Supply Current	Icc	10	mA	
Noise Figure	NF	1.1	dB	
Power Gain	Gp	18	dB	
Input Return Loss	RLin	-8	dB	
Output Return Loss	RLout	-12	dB	
Output third order intercept point	OIP3	9	dBm	

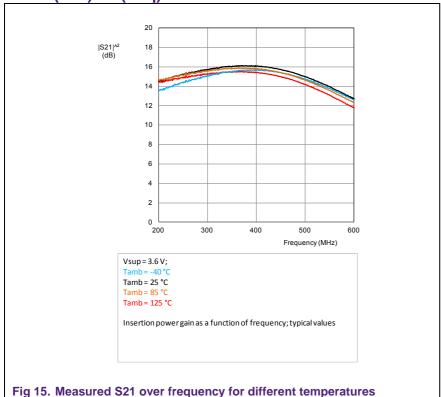
#### **Table 3. Bill Of Materials**

Value	Description	Footprint	Manufacturer
BFU530A	Transistor	SOT23	NXP Semiconductors
4.7 pF	Capacitor	0603	Various
10 pF	Capacitor	0603	Various
390 pF	Capacitor	0603	Various
390 pF	Capacitor	0603	Various
100 nF	Capacitor	0603	Various
4.7 uF	Capacitor	0603	Various
10 Ω	Resistor	0603	Various
3.9 kΩ	Resistor	0603	Various
8.2 kΩ	Resistor	0603	Various
1.5 nH	Inductor	0603	Murata LQW18A
6.8 nH	Inductor	0603	Murata LQW18A
12 nH	Inductor	0603	Murata LQW18A

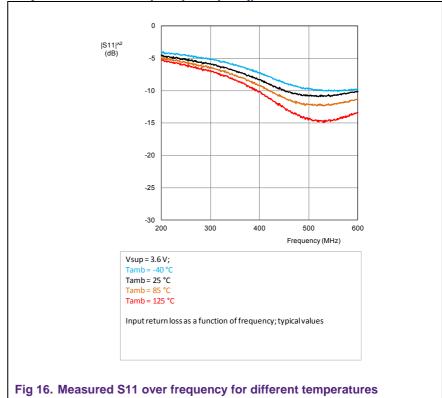
## **Example LNA design using BFU530A**

# 7. Characterization of LNA over temperature and supply voltage

7.1 Gain (S21) = f(freq)



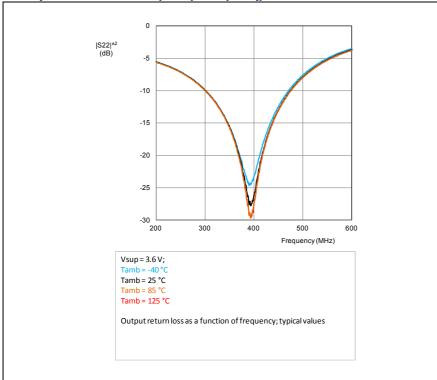
7.2 Input return-loss (S11) = f (freq)



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## **Example LNA design using BFU530A**

7.3 Output return-loss (S22) = f (freq)



**7.4** Isolation (S12) = f (freq)

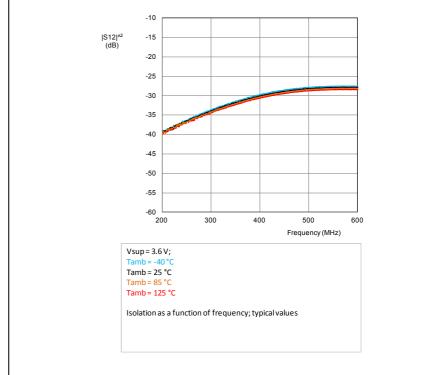


Fig 18. Measured S12 over frequency for different temperatures

Fig 17. Measured S22 over frequency for different temperatures

## **Example LNA design using BFU530A**

# 7.5 Output third-order intercept point (OIP3) = f (Tamb)

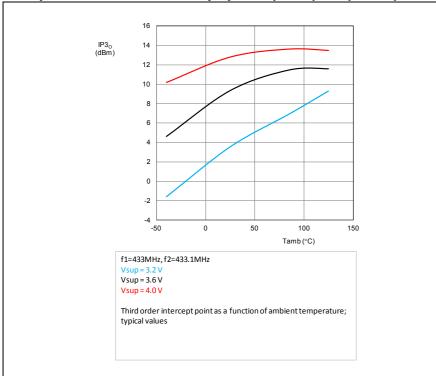


Fig 19. Measured OIP3 over temperature for different supply voltages

## 7.6 Output Power at 1 dB compression (P1dB) = f (Tamb)

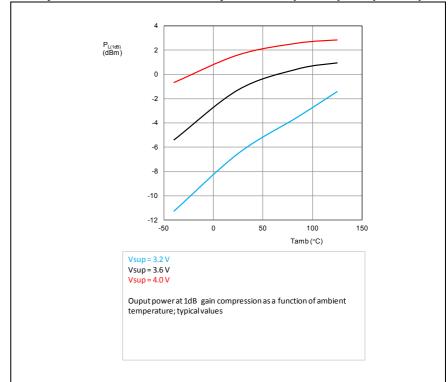


Fig 20. Measured 1dB compression point over temperature for different supply voltages

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**Example LNA design using BFU530A** 

# 7.7 Noise Figure = f (Freq)

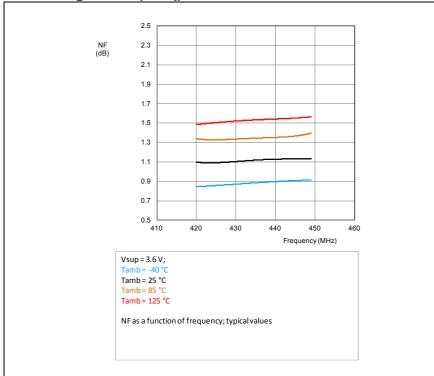


Fig 21. Measured Noise Figure over temperature for different supply voltages

#### **Example LNA design using BFU530A**

## 8. Conclusions / recommendations

With BFU530A a ISM 433 MHz LNA design with NF close to 1.3dB can be implemented, for this the input return loss has to be compromised. The circuit can be used as a base for derivative designs, matching to other frequencies can be done by tuning relevant capacitors and inductors.

For improvements on linearity it could be recommended to increase the DC biasing current and increase values for decoupling capacitors to GND, for example on the biasing network in case the matching inductor is in the configuration as shown in the ADS schematics.

	BFU520 series	BFU530 series	BFU550 series
Lowest Noise at low supply current	Х		
Low Noise and medium Linearity		х	
Low Noise and high Linearity, high Icc			Х

## 8.1 Tuning the design for other frequencies

This LNA can be tuned to other frequencies as well. The presented configuration has been designed for a low bandwidth application (Center frequency/required bandwidth = approx 10-100 depending on the used components).

The LNA can be tuned to other frequencies following section 5.4 till 5.6. The use of printed inductors or micro-strip elements is recommended above 1GHz to prevent gain drop.

For wideband amplifiers a feedback is recommended which can be implemented on the existing board.

A reference design for a wideband amplifier, applying feedback, is planned to be issued. Please regularly visit the NXP PIP pages to monitor availability of BFU5- series related AN's.

## 9. References

BFU530A datasheet

BFU5xxA starter-kit (OM7961) User Manual, UM10772

#### **Example LNA design using BFU530A**

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> Date of release: 20 January 2014 Document identifier: AN11379